

ABSTRACT OF THE DISCLOSURE

An electronic apparatus of the present invention comprises an electronic circuit board; an electrically conductive casing for  
5 encasing the electronic circuit board; a semiconductor element module electrically connected to the electronic circuit board; and a resin fixture intervening between the electrically conductive casing and the semiconductor element module, the resin fixture mounted with the semiconductor element module and fitted to the  
10 electrically conductive casing. As a result, the resin fixture can suppress a transfer of heat generated in the electronic circuit board to the semiconductor element module.